## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Wolfgang Hetzel et al. Examiner:

Serial No.: 10/577,173 Group Art Unit:

Filed: April 26, 2006 Docket: I441.141.101

Title: SEMICONDUCTOR DEVICE WITH PLASTIC PACKAGE MOLDING

COMPOUND, SEMICONDUCTOR CHIP AND LEADFRAME AND

METHOD FOR PRODUCING SAME

## RESPONSE TO THE NOTIFICATION OF DEFECTIVE RESPONSE

## **Mail Stop Missing Parts**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the "Notification of Defective Response" (see enclosed copy), the previously filed executed Declaration, Power of Attorney is enclosed. The Transmittal filed April 26, 2006 had the International Application No. (PCT/DE2004/0023749) incorrect. The **Declaration enclosed has the correct International Application No. (PCT/DE2004/002374).** 

No fees are required, however, if such fees are required, the Patent Office is hereby authorized to charge Deposit Account No. 50-0471.

Applicants assume the application is now in proper order and in condition for examination. Please direct any inquiries to the undersigned attorney at (612) 767-2503.

Respectfully submitted,

Wolfgang Hetzel et al.,

By their attorneys,

DICKE, BILLIG & CZAJA, PLLC Fifth Street Towers, Suite 2250 100 South Fifth Street Minneapolis, MN 55402 Telephone: (612) 573-2000

Facsimile: (612) 573-2005

Dated: 09/16/2009 Mark L. Gleason

MLG:cjs Mark L. Gleason Reg. No. 39,998